

Test methods for electrical materials, printed boards and other interconnection structures and assemblies —

**Part 3: Test methods for
interconnection structures
(printed boards)**

ICS 31.180

National foreword

This British Standard is the UK implementation of EN 61189-3:2008. It is identical to IEC 61189-3:2007. It supersedes BS EN 61189-3:1997 which is withdrawn.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic assembly technology.

A list of organizations represented on this committee can be obtained on request to its secretary.

This publication does not purport to include all the necessary provisions of a contract. Users are responsible for its correct application.

Compliance with a British Standard cannot confer immunity from legal obligations.

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